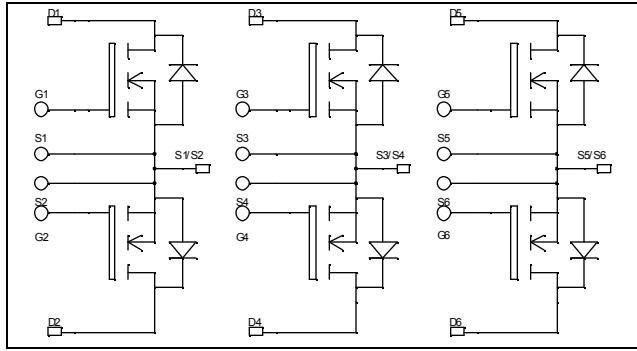


**Triple dual common source  
MOSFET Power Module**

**V<sub>DSS</sub> = 200V**  
**R<sub>DSon</sub> = 16mΩ typ @ T<sub>j</sub> = 25°C**  
**I<sub>D</sub> = 104A @ T<sub>c</sub> = 25°C**



#### Application

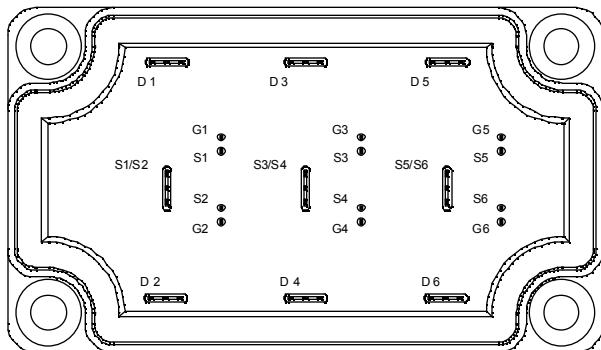
- AC Switches
- Switched Mode Power Supplies
- Uninterruptible Power Supplies

#### Features

- Power MOS 7<sup>®</sup> MOSFETs
  - Low R<sub>DSon</sub>
  - Low input and Miller capacitance
  - Low gate charge
  - Avalanche energy rated
  - Very rugged
- Kelvin source for easy drive
- Very low stray inductance
  - Symmetrical design
  - Lead frames for power connections
- High level of integration

#### Benefits

- Outstanding performance at high frequency operation
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Solderable terminals both for power and signal for easy PCB mounting
- Very low (12mm) profile
- Each leg can be easily paralleled to achieve a dual common source configuration of three times the current capability
- RoHS Compliant



#### Absolute maximum ratings

Symbol	Parameter	Max ratings	Unit
V <sub>DSS</sub>	Drain - Source Breakdown Voltage	200	V
I <sub>D</sub>	Continuous Drain Current	T <sub>c</sub> = 25°C	A
		T <sub>c</sub> = 80°C	
I <sub>DM</sub>	Pulsed Drain current	416	
V <sub>GS</sub>	Gate - Source Voltage	±30	V
R <sub>DSon</sub>	Drain - Source ON Resistance	19	mΩ
P <sub>D</sub>	Maximum Power Dissipation	T <sub>c</sub> = 25°C	W
I <sub>AR</sub>	Avalanche current (repetitive and non repetitive)	104	A
E <sub>AR</sub>	Repetitive Avalanche Energy	50	mJ
E <sub>AS</sub>	Single Pulse Avalanche Energy	3000	

 **CAUTION:** These Devices are sensitive to Electrostatic Discharge. Proper Handing Procedures Should Be Followed. See application note APT0502 on [www.microsemi.com](http://www.microsemi.com)

All ratings @  $T_j = 25^\circ\text{C}$  unless otherwise specified

**Electrical Characteristics**

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{GS} = 0\text{V}$ , $V_{DS} = 200\text{V}$	$T_j = 25^\circ\text{C}$			250	$\mu\text{A}$
		$V_{GS} = 0\text{V}$ , $V_{DS} = 160\text{V}$	$T_j = 125^\circ\text{C}$			1000	
$R_{DS(on)}$	Drain – Source on Resistance	$V_{GS} = 10\text{V}$ , $I_D = 52\text{A}$			16	19	$\text{m}\Omega$
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS} = V_{DS}$ , $I_D = 2.5\text{mA}$		3		5	$\text{V}$
$I_{GSS}$	Gate – Source Leakage Current	$V_{GS} = \pm 30\text{ V}$ , $V_{DS} = 0\text{V}$				$\pm 100$	$\text{nA}$

**Dynamic Characteristics**

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
$C_{iss}$	Input Capacitance	$V_{GS} = 0\text{V}$ $V_{DS} = 25\text{V}$ $f = 1\text{MHz}$		7220			$\text{pF}$
$C_{oss}$	Output Capacitance			2330			
$C_{rss}$	Reverse Transfer Capacitance			146			
$Q_g$	Total gate Charge	$V_{GS} = 10\text{V}$ $V_{Bus} = 100\text{V}$ $I_D = 104\text{A}$		140			$\text{nC}$
$Q_{gs}$	Gate – Source Charge			53			
$Q_{gd}$	Gate – Drain Charge			67			
$T_{d(on)}$	Turn-on Delay Time	<b>Inductive switching @ 125°C</b> $V_{GS} = 15\text{V}$ $V_{Bus} = 133\text{V}$ $I_D = 104\text{A}$ $R_G = 5\Omega$		32			$\text{ns}$
$T_r$	Rise Time			64			
$T_{d(off)}$	Turn-off Delay Time			88			
$T_f$	Fall Time			116			
$E_{on}$	Turn-on Switching Energy	<b>Inductive switching @ 25°C</b> $V_{GS} = 15\text{V}$ , $V_{Bus} = 133\text{V}$ $I_D = 104\text{A}$ , $R_G = 5\Omega$		849			$\mu\text{J}$
$E_{off}$	Turn-off Switching Energy			929			
$E_{on}$	Turn-on Switching Energy	<b>Inductive switching @ 125°C</b> $V_{GS} = 15\text{V}$ , $V_{Bus} = 133\text{V}$ $I_D = 104\text{A}$ , $R_G = 5\Omega$		936			$\mu\text{J}$
$E_{off}$	Turn-off Switching Energy			986			

**Source - Drain diode ratings and characteristics**

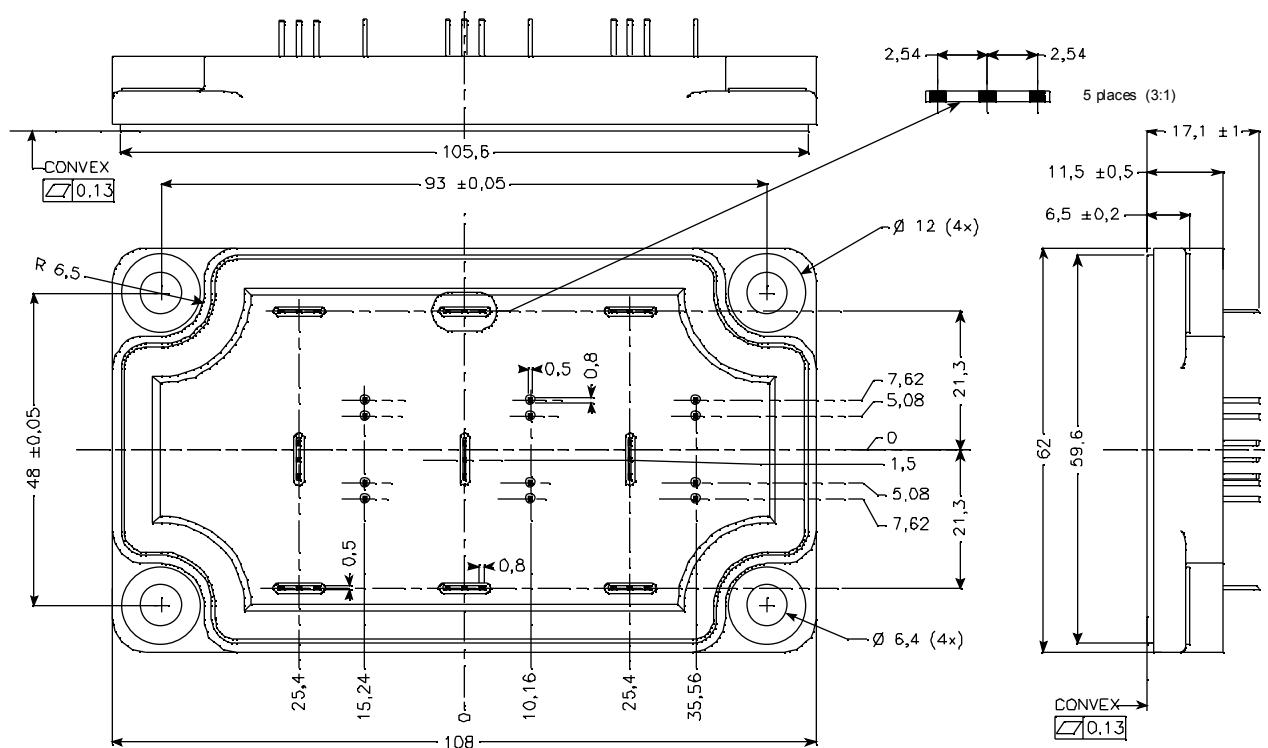
Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
$I_S$	Continuous Source current (Body diode)		$T_c = 25^\circ\text{C}$			104	$\text{A}$
			$T_c = 80^\circ\text{C}$			77	
$V_{SD}$	Diode Forward Voltage	$V_{GS} = 0\text{V}$ , $I_S = -104\text{A}$				1.3	$\text{V}$
$dv/dt$	Peak Diode Recovery ①					5	$\text{V/ns}$
$t_{rr}$	Reverse Recovery Time	$I_S = -104\text{A}$ $V_R = 133\text{V}$ $dI_S/dt = 100\text{A}/\mu\text{s}$	$T_j = 25^\circ\text{C}$		360		$\text{ns}$
$Q_{rr}$	Reverse Recovery Charge		$T_j = 25^\circ\text{C}$		6.7		$\mu\text{C}$

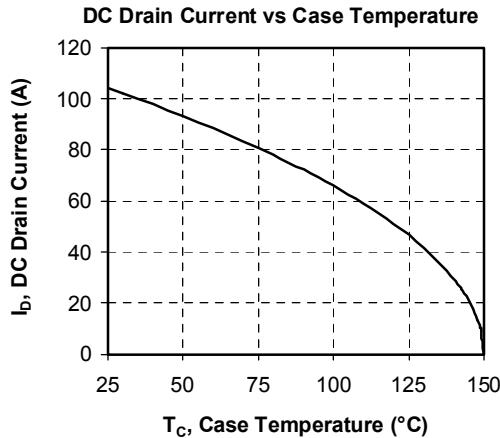
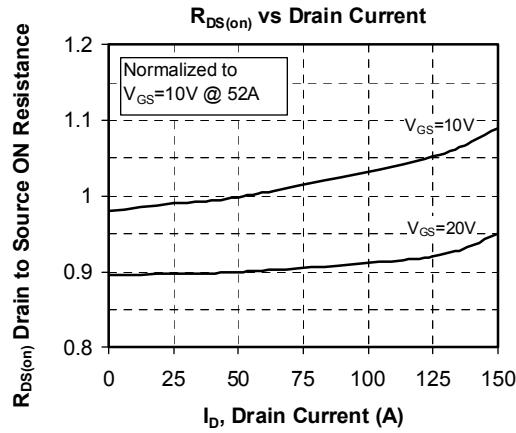
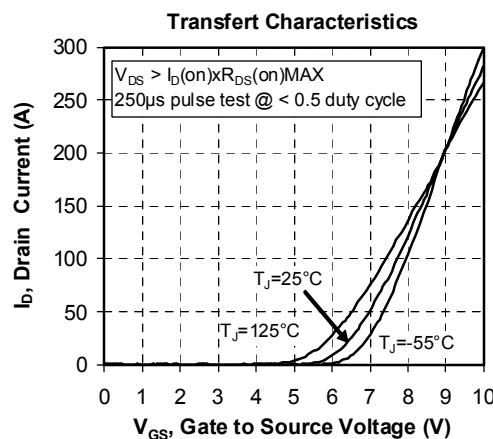
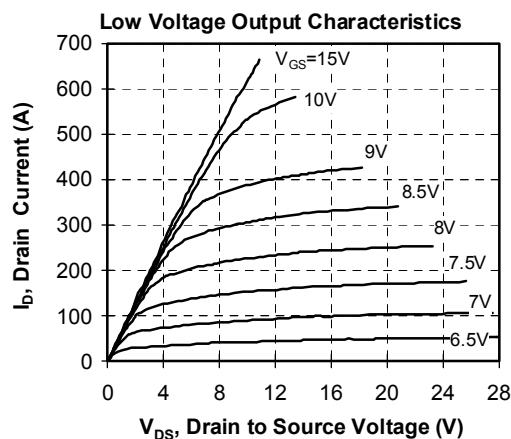
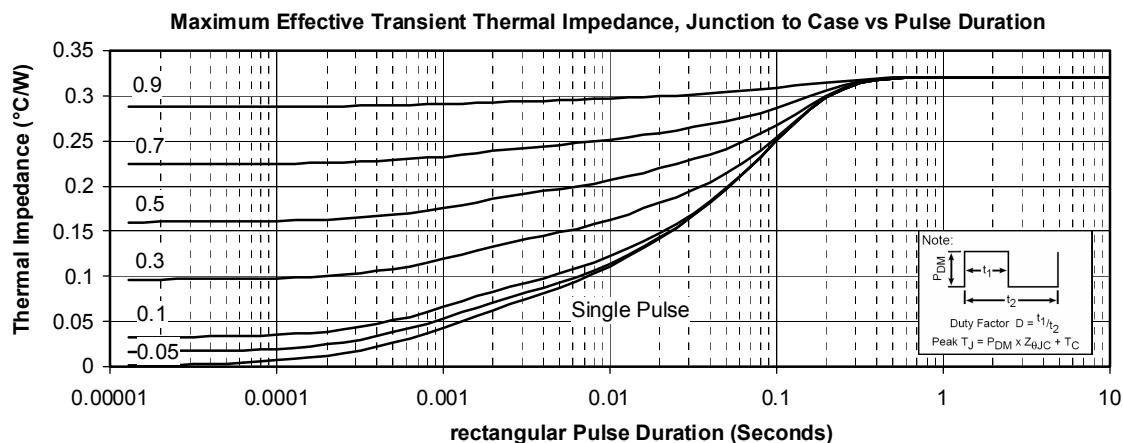
 ①  $dv/dt$  numbers reflect the limitations of the circuit rather than the device itself.

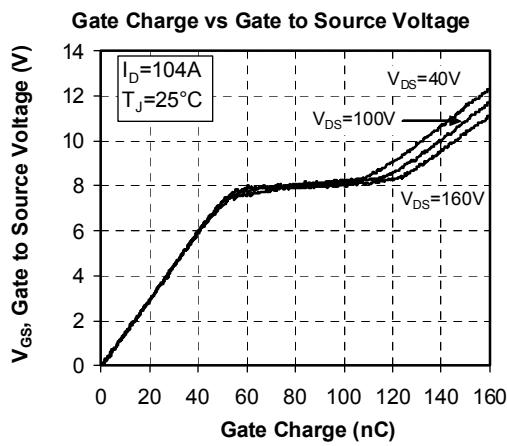
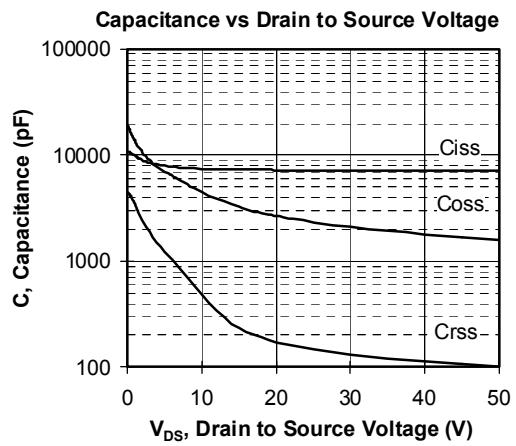
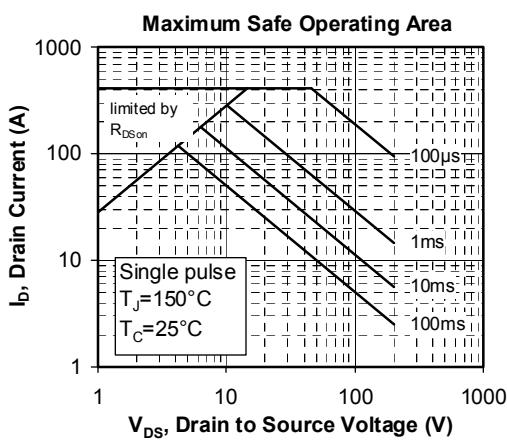
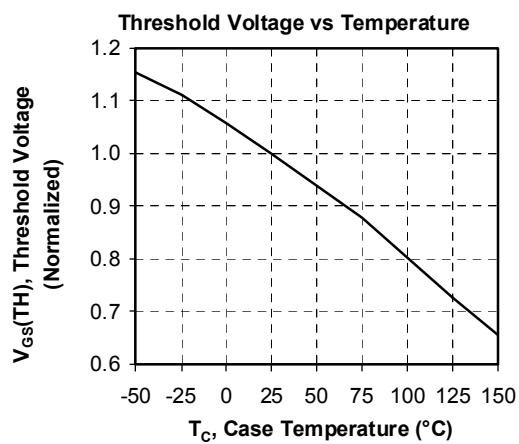
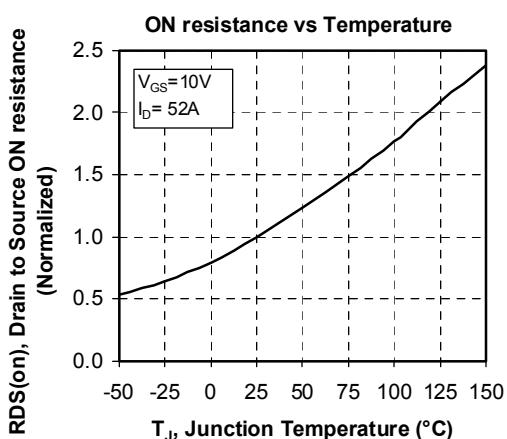
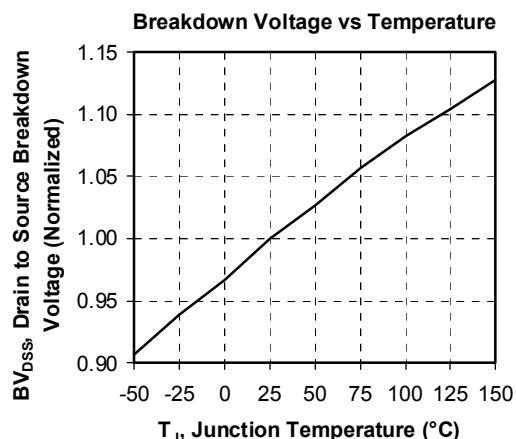
 $I_S \leq -104\text{A}$     $di/dt \leq 700\text{A}/\mu\text{s}$     $V_R \leq V_{DSS}$     $T_j \leq 150^\circ\text{C}$

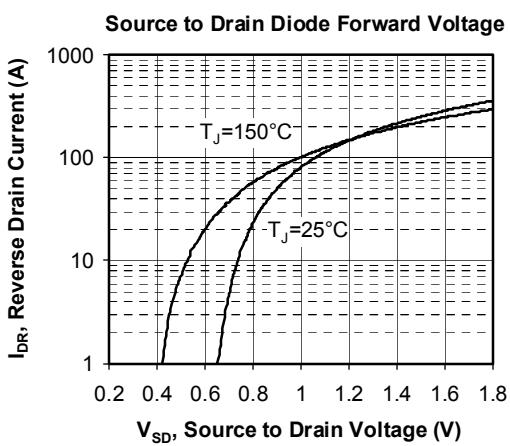
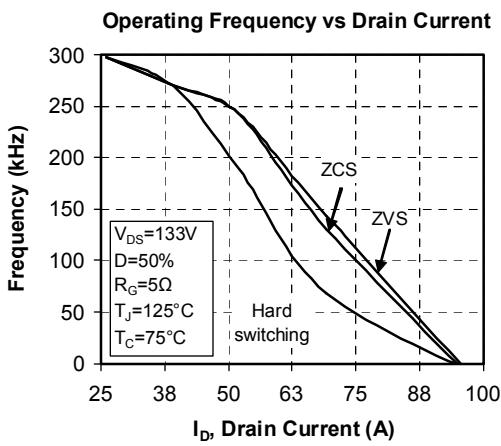
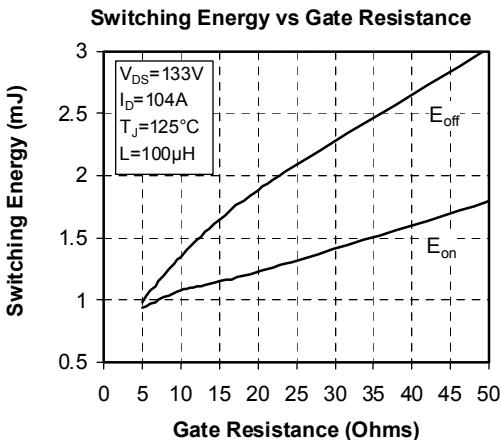
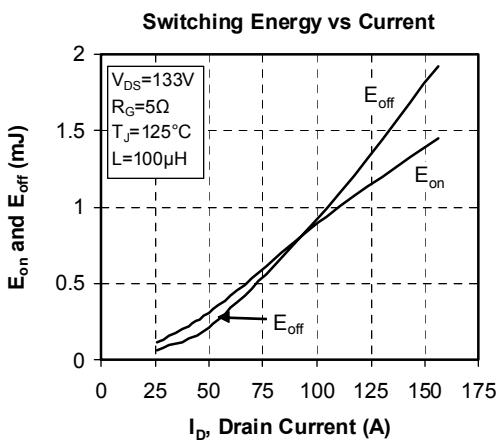
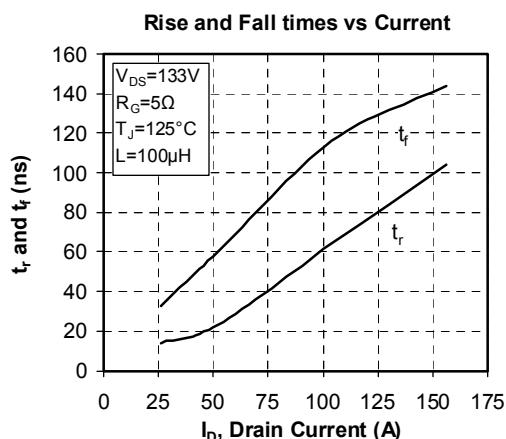
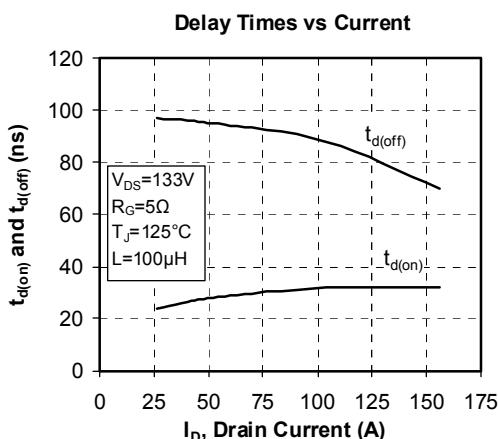
**Thermal and package characteristics**
**Symbol**    **Characteristic**
**Min**    **Typ**    **Max**    **Unit**

$R_{thJC}$	Junction to Case Thermal Resistance			0.32	$^{\circ}\text{C}/\text{W}$
$V_{ISOL}$	RMS Isolation Voltage, any terminal to case t = 1 min, I isol < 1mA, 50/60Hz		2500		V
$T_J$	Operating junction temperature range		-40	150	$^{\circ}\text{C}$
$T_{STG}$	Storage Temperature Range		-40	125	
$T_C$	Operating Case Temperature		-40	100	
Torque	Mounting torque	To heatsink	M6	3	5 N.m
Wt	Package Weight			250	g

**SP6-P Package outline (dimensions in mm)**

 See application note 1902 - Mounting Instructions for SP6-P (12mm) Power Modules on [www.microsemi.com](http://www.microsemi.com)

**Typical Performance Curve**






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